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August 2015

FGA6530WDF 650 V, 30 A Field Stop Trench IGBT

Features

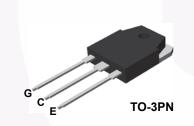
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- · Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)}$ = 1.8 V(Typ.) @ I_C = 30 A
- 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- · Fast Switching
- Tighten Parameter Distribution
- · RoHS Compliant

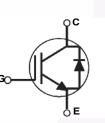
General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance for welder and industial applications where low conduction and switching losses are essential.

Applications

- · Welder and Industrial Application
- Power Factor Correction





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		FGA6530WDF	Unit	
V _{CES}	Collector to Emitter Voltage		650	V	
V/	Gate to Emitter Voltage		± 20	V	
V _{GES}	Transient Gate to Emitter Voltage		± 30	V	
I _C	Collector Current	@ T _C = 25 ^o C	60	А	
'C	Collector Current	@ T _C = 100°C	30	А	
I _{LM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	90	А	
I _{CM (2)}	Pulsed Collector Current		90	А	
I _F	Diode Forward Current	@ T _C = 25°C	30	А	
	Diode Forward Current	@ T _C = 100°C	15	А	
I _{FM}	Pulsed Diode Maximum Forward Curren	t	60	А	
P _D	Maximum Power Dissipation	@ T _C = 25°C	176	W	
' D	Maximum Power Dissipation	@ T _C = 100°C	88	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T _{stg}	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} = 90 A, R_{G} = 55.9 $\Omega,$ Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	FGA6530WDF	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.85	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	3.5	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity	
FGA6530WDF	FGA6530WDF	TO-3PN	Tube	-	-	30	

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	650	-	-	V
ΔBV_{CES} / ΔT_J	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.52	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 30 mA, V _{CE} = V _{GE}	4.1	5.6	7.6	V
GE((II)		$I_{\rm C} = 30$ A, $V_{\rm GE} = 15$ V	-	1.8	2.3	V
V _{CE(sat)} Collector to Emitter Saturation Voltage		$I_{C} = 30 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$	-	2.4	-	V
Dynamic C	Characteristics					
C _{ies}	Input Capacitance		-	1072	-	pF
C _{oes}	Output Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	36	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	13	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		T -	12	-	ns
t _r	Rise Time	-	-	19.2	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 30 A,	-	42.4	-	ns
t _f	Fall Time	R _G = 6 Ω, V _{GE} = 15 V,	-	7.2	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	960	-	uJ
E _{off}	Turn-Off Switching Loss		-	162	-	uJ
E _{ts}	Total Switching Loss		-	1122	-	uJ
t _{d(on)}	Turn-On Delay Time		-	12.8	-	ns
t _r	Rise Time		-	27.2	-	ns
t _{d(off)}	Turn-Off Delay Time	V_{CC} = 400 V, I _C = 30 A, R _G = 6 Ω, V _{GE} = 15 V, Inductive Load, T _C = 175 ^o C	-	46.4	-	ns
t _f	Fall Time		-	12.8	-	ns
	Turn-On Switching Loss		-	1430	-	uJ
E _{on}	rum-on Switching Loss					
E _{on} E _{off}	Turn-Off Switching Loss	-	-	310	-	uJ

Electrical Characteristics of the IGBT (Continued)

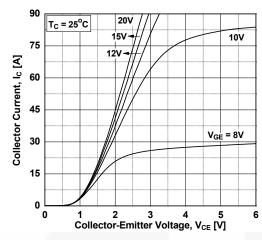
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 30 A, V _{GE} = 15 V	-	37.4	-	nC
Q _{ge}	Gate to Emitter Charge		-	7.2	-	nC
Q _{gc}	Gate to Collector Charge		-	15	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions			Min.	Тур.	Мах	Unit
V _{FM}	Diode Forward Voltage	I _F =	15 A		T _C = 25 ^o C	-	1.7	2.6	V
					T _C = 175°C	-	1.62	-	v
E _{rec}	Reverse Recovery Energy				T _C = 175 ^o C		76	-	uJ
t _{rr}	Diode Reverse Recovery Time		15 Α, dI _F /dt = 200 Α/μs		T _C = 25 ^o C	-	81	-	ns
					T _C = 175°C	-	257		
Q _{rr}	Diode Reverse Recovery Charge			ľ	T _C = 25 ^o C	-	254	-	nC
SIL	block hore recovery charge			ľ	T _C = 175 ^o C	-	1189	-	

Typical Performance Characteristics

Figure 1. Typical Output Characteristics





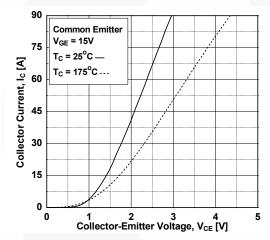


Figure 5. Saturation Voltage vs. V_{GE}

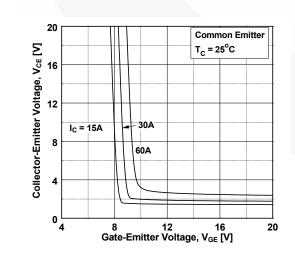
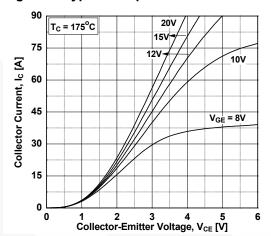
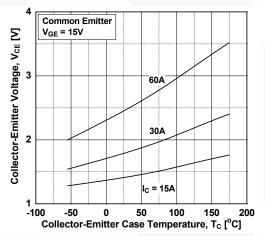


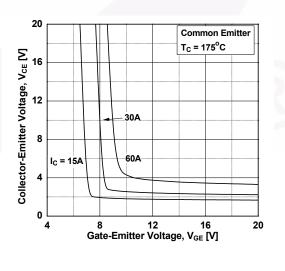
Figure 2. Typical Output Characteristics











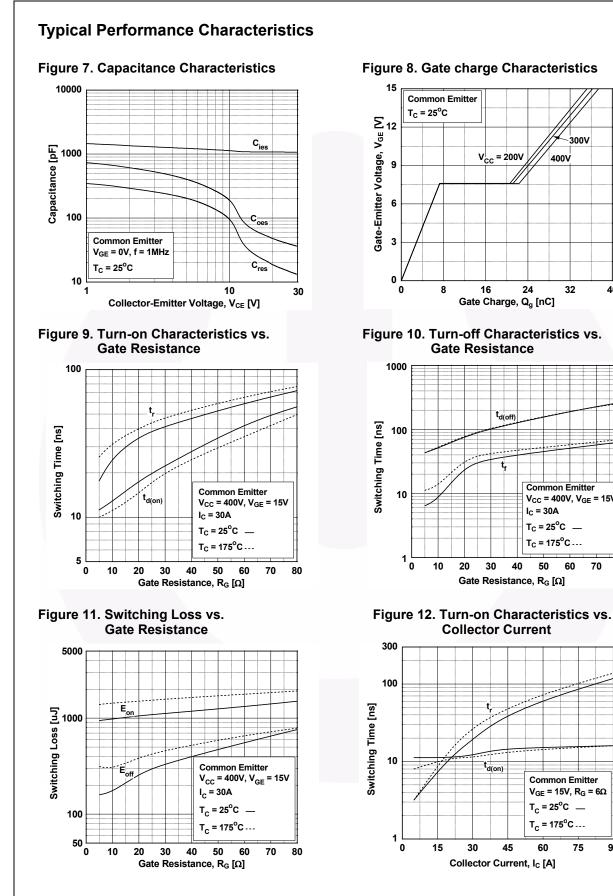


Figure 8. Gate charge Characteristics

V_{CC} = 200V

16

t_{d(off)}

t,

30 40

t_{d(on)}

45

30

24

300V

400V

32

Common Emitter

I_C = 30A

50

T_C = 25°C

T_C = 175°C

V_{CC} = 400V, V_{GE} = 15V

60 70 80

Common Emitter

T_C = 175°C

60

V_{GE} = 15V, R_G = 6Ω T_c = 25°C ____

75

90

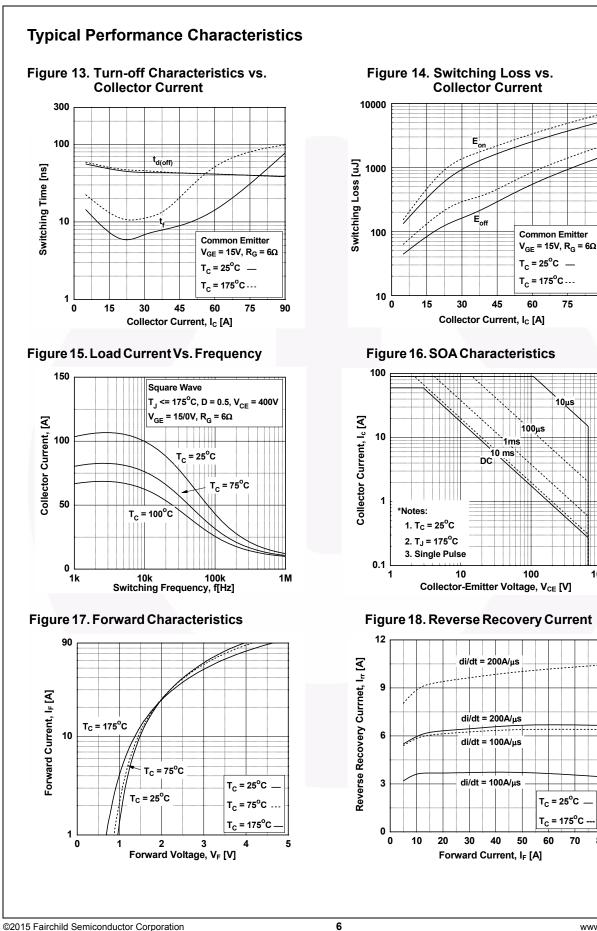
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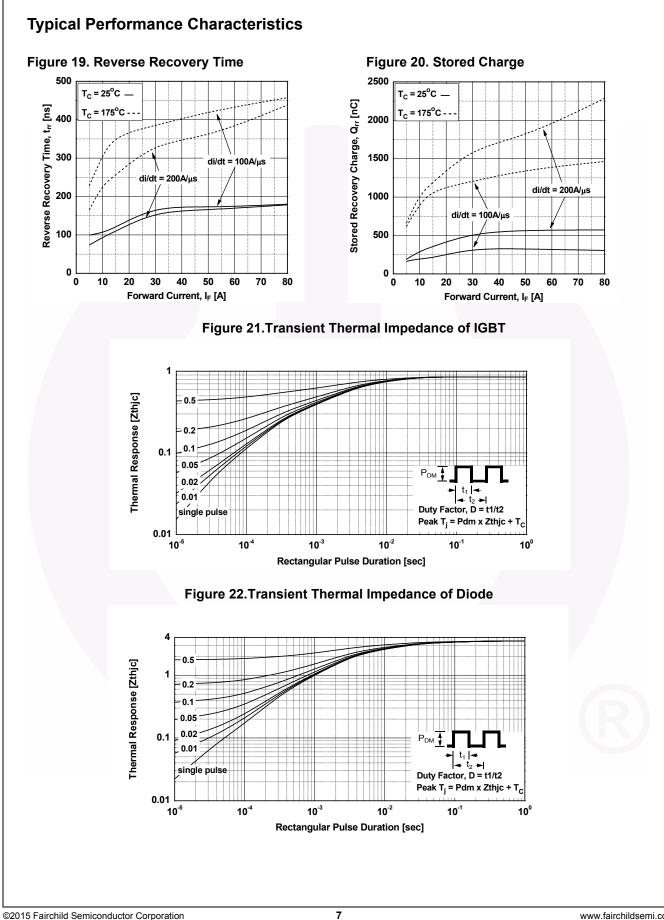
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1000

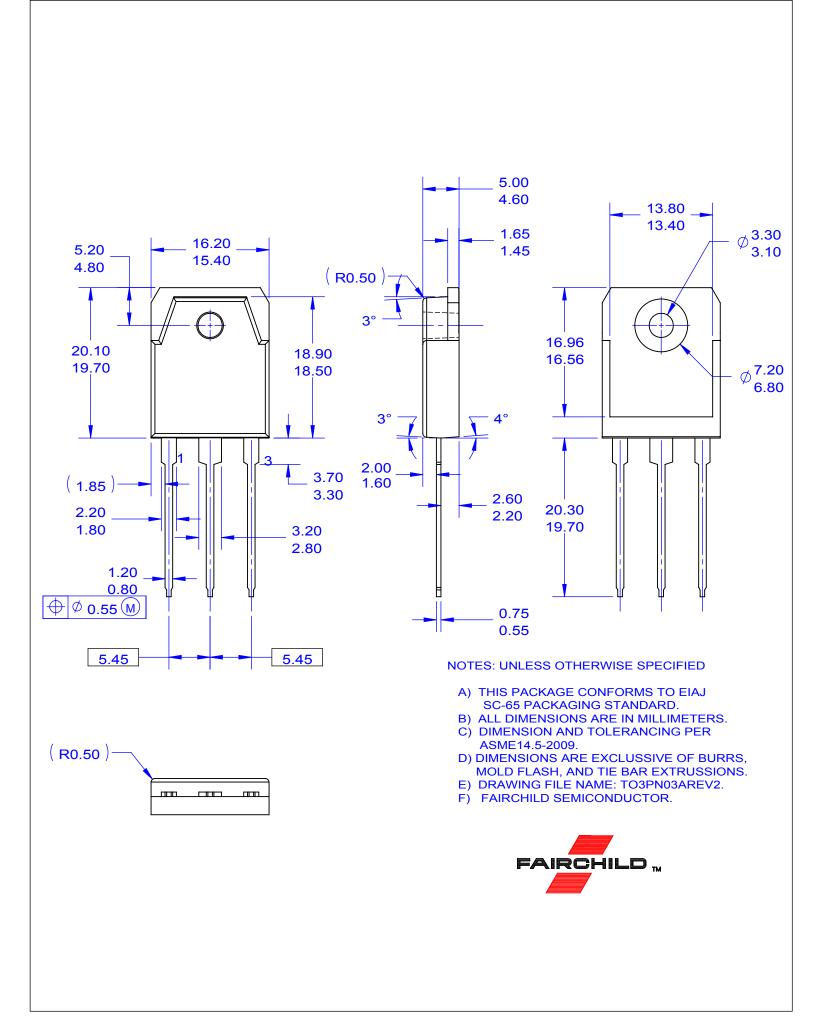
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FGA6530WDF — 650 V, 30 A Field Stop Trench IGBT



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